

Silicon Programmable Unijunction Transistors

... designed to enable the engineer to "program" unijunction characteristics such as R_{BB} , η , I_V , and I_P by merely selecting two resistor values. Application includes thyristor-trigger, oscillator, pulse and timing circuits. These devices may also be used in special thyristor applications due to the availability of an anode gate.

- Programmable — R_{BB} , η , I_V and I_P
- Hermetic TO-18 Package
- Low On-State Voltage — 1.5 Volts Maximum @ $I_P = 50$ mA
- Low Gate to Anode Leakage Current — 5 nA Maximum
- High Peak Output Voltage — 16 Volts Typical
- Low Offset Voltage — 0.35 Volt Typical ($R_G = 10$ k ohms)

2N6116
2N6117
2N6118

PUTs
 40 VOLTS — 250 mW



*MAXIMUM RATINGS

Rating	Symbol	Value	Unit
Repetitive Peak Forward Current 100 μ s Pulse Width, 1% Duty Cycle 20 μ s Pulse Width, 1% Duty Cycle	I_{TRM}	1 2	Amps
Non-Repetitive Peak Forward Current 10 μ s Pulse Width	I_{TSM}	5	Amps
DC Forward Anode Current Derate Above 25°C	I_T	200 2	mA mW/°C
DC Gate Current	I_G	± 20	mA
Gate to Cathode Forward Voltage	V_{GKF}	40	Volts
Gate to Cathode Reverse Voltage	V_{GKR}	5	Volts
Gate to Anode Reverse Voltage	V_{GAR}	40	Volts
Anode to Cathode Voltage	V_{AK}	± 40	Volts
Forward Power Dissipation @ $T_A = 25^\circ\text{C}$ Derate Above 25°C	P_F $1/\theta_{JA}$	250 2.5	mW mW/°C
Operating Junction Temperature Range	T_J	-55 to +125	°C
Storage Temperature Range	T_{stg}	-65 to +200	°C

*Indicates JEDEC Registered Data.

NJ Semi-Conductors reserves the right to change test conditions, parameters limits and package dimensions without notice information furnished by NJ Semi-Conductors is believed to be both accurate and reliable at the time of going to press. However NJ Semi-Conductors assumes no responsibility for any errors or omissions discovered in its use. NJ Semi-Conductors encourages customers to verify that datasheets are current before placing orders.



2N6116 • 2N6117 • 2N6118

*ELECTRICAL CHARACTERISTICS ($T_A = 25^\circ\text{C}$ unless otherwise noted.)

Characteristic	Fig. No.	Symbol	Min	Typ	Max	Unit
Offset Voltage ($V_S = 10\text{ Vdc}, R_G = 1\text{ M}\Omega$) ($V_S = 10\text{ Vdc}, R_G = 10\text{ k ohms}$) All Types	1	V_T	0.2 0.2 0.2	0.70 0.50 0.40	1.6 0.8 0.8	Volts
Gate to Anode Leakage Current ($V_S = 40\text{ Vdc}, T_A = 25^\circ\text{C}, \text{Cathode Open}$) ($V_S = 40\text{ Vdc}, T_A = 75^\circ\text{C}, \text{Cathode Open}$)	—	I_{GAO}	—	1 30	5 75	nAdc
Gate to Cathode Leakage Current ($V_S = 40\text{ Vdc}, \text{Anode to Cathode Shorted}$)	—	I_{GKS}	—	5	50	nAdc
Peak Current ($V_S = 10\text{ Vdc}, R_G = 1\text{ M}\Omega$) ($V_S = 10\text{ Vdc}, R_G = 10\text{ k ohms}$)	2,9,14	I_p	—	1.25 0.19 0.08 4 1.20 0.70	2 0.3 0.15 5 2 1	μA
Valley Current ($V_S = 10\text{ Vdc}, R_G = 1\text{ M}\Omega$) ($V_S = 10\text{ Vdc}, R_G = 10\text{ k ohms}$)	1,4,5	I_v	—	18 18 70 50	50 25 — 270	μA
Forward Voltage ($I_f = 50\text{ mA Peak}$)	1,6	V_F	—	0.8	1.5	Volts
Peak Output Voltage ($V_B = 20\text{ Vdc}, C_C = 0.2\text{ }\mu\text{F}$)	3,7	V_o	6	16	—	Volts
Pulse Voltage Rise Time ($V_B = 20\text{ Vdc}, C_C = 0.2\text{ }\mu\text{F}$)	3	t_r	—	40	60	ns

*Indicates JEDEC Registered Data.

FIGURE 1 - ELECTRICAL CHARACTERIZATION

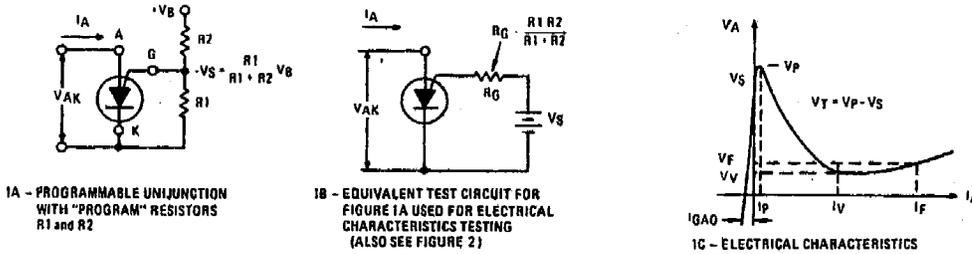


FIGURE 2 - PEAK CURRENT (I_p) TEST CIRCUIT

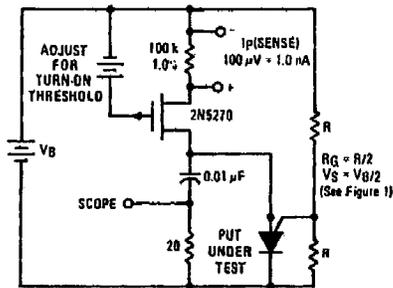


FIGURE 3 - V_o AND t_r TEST CIRCUIT

